DECLARATION FOR U.S. PATENT APPLICATION

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

SUBSTRATE SUPPORTING APPARATUS

the specification	of which is attached hereto unle	ss the following is checke	d					
was file	ed on	as United States Application Number or PCT International Application						
		and was amended or	(if applicable).					
I hereby state the amended by any	at I have reviewed and understan amendment referred to above.	d the contents of the abov	e-identified specification, including	the claim(s), as				
I acknowledge to Regulations, § 1	ne duty to disclose information w	hich is material to patenta	ability as defined in Title 37, Code o	f Federal				
inventor's certifi	oreign priority benefits under Tit cate listed below and have also in ore that of the application for whi	dentified below any foreig	§ 119 (a) - (d) of any foreign applic an application for patent or inventor's	ation(s) for patent of scertificate having				
2003-281206		Japan	28/July/2003	Priority Claimed X Yes No				
(List prior foreign applications. See note A)	(Number)	(Country)	(Day/Month/Year Filed)	Yes No				
	(Number)	(Country)	(Day/Month/Year Filed)					
	(Number)	(Country)	(Day/Month/Year Filed)	Yes No				
	(Number)	(Country)	(Day/Month/Year Filed)	_ Yes _ No				
(See note B)	See attached list for addition	al prior foreign applicatio	ns					
provided by the i material to paten	r of each of the claims of this applications of this applications. The contractions of	plication is not disclosed i d States Code, § 112, I ack de of Federal Regulations	United States application(s) listed be not the prior United States application knowledge the duty to disclose informs, § 1.56 which became available bethis application. Statu	in the manner mation which is ween the filing date				
(List prior U.S.	(Application Serial No.)	(Filing Date)	Patented Pendin	ng Abandoned				
Applications)		(I ming Date)	Patented Pendir	ng Abandoned				
	(Application Serial No.)	(Filing Date)		_				
	(Application Serial No.)	(Filing Date)	Patented Pendir	ng Abandoned				
	(Application Serial No.)	(Filing Date)	Patented Pendir	ng Abandoned				

I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

Customer Number

23850 PATENT TRADEMARK OFFICE

Please direct all communications to the following address:

Customer Number

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, § 1001 and that such willful false statements my jeopardize the validity of the application or any patent issued thereon.

(See note C)	Full name of sole or first inventor (given name, family name)			nily name)	Minoru MATSUZAWA				
	Inventor's Signature						19,	2003	
	Residence Post Office Address	c/o SIPEC	Japan O			Japanese , Bunkyo-ku,	Tokyo		
	Full name of second Inventor's Signature - Residence	tatsuro	•		Date _	o YOSHIDA December Japanese	19,	2003	
	Post Office Address						Гокуо		
	Full name of third inv	ventor (given na	ıme, family nam	ne)	· · · · · · · · · · · · · · · · · · ·				
	Inventor's Signature - Residence								
	Post Office Address			Ciuzens	snip				
	Full name of fourth in	nventor (given r	name, family na	me)	•				
	Inventor's Signature -				Date _				
	Residence Post Office Address			Citizens	ship				
	Full name of fifth inv		me, family name						
	Inventor's Signature -				Date _				
	Residence Post Office Address								
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	Full name of sixth inv						·		
	Inventor's Signature -								
	Residence Post Office Address			Citizens	hip				
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